

High Current, Power Inductors

HCP0605 Series







Description

- · Halogen free
- 125°C maximum total temperature operation
- 5.3 x 6.1 x 4.95mm surface mount package
- · Powder Iron core material
- · High current carrying capacity, high permeability
- Frequency range up to 1MHz
- · RoHS compliant

Applications

- Voltage Regulator Module (VRM)
- Multi-phase regulators
- Desktop and server VRMs and EVRDs
- Point of load modules
- Notebook regulators
- · Data networking and storage systems
- Graphics cards
- Battery power systems

Environmental Data

- Storage temperature range: -40°C to +125°C
- Operating temperature range: -40°C to +125°C (with derated current)
- Solder reflow temperature: J-STD-020D compliant

Packaging

 Supplied in tape and reel packaging, 1,000 parts per reel, 13" diameter reel

	Product Specifications					
	OCL1	FLL ²	I _{rms³}	I _{sat⁴}	DCR mΩ@20°C	
Part Number⁵	μH ± 15%	μH Minimum	Amps	Amps@25°C	Maximum	K-factor4
HCP0605-R10-R	0.095	0.06	53	20	0.40	120.5

¹ Open Circuit Inductance (OCL) Test Parameters: 100kHz, 0.10V_{rms}, 0.0Adc

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- \bullet HCP0605 = Product code and size
- xxx= Inductance value in μ H, R = decimal point.
- "-R" suffix = RoHS compliant

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² Full Load Inductance (FLL) Test Parameters: 100kHz, 0.1V_{rms}, I_{sat}

² For Local moderates (LEZ) restrict and the second of the second of

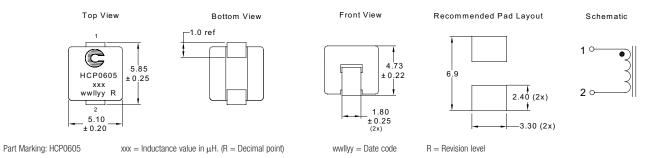
⁴ Isat: Peak current for approximately 30% rolloff at 25°C.

⁵ K-factor: Used to determine B_{p-p} for core loss (see graph). $B_{p-p} = K * L * \Delta I_{-} B_{p-p}$: (Gauss), K: (K-factor from table), L: (inductance in μ H), ΔI_{-} (peak-to-peak ripple current in amps).

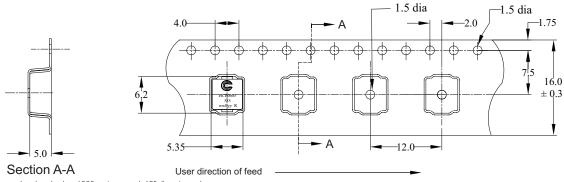
⁶ Part Number Definition: HCP0605-xxx-R



Dimensions - mm

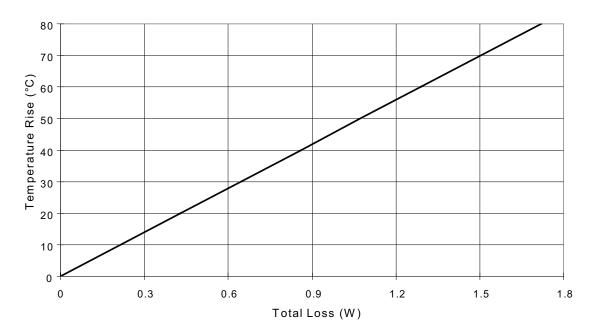


Packaging Information - mm



Supplied in tape-and-reel packaging, 1000 parts per reel, 13" diameter reel.

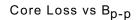
Temperature Rise vs. Total Loss

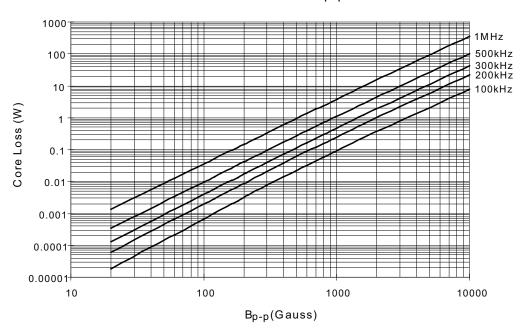


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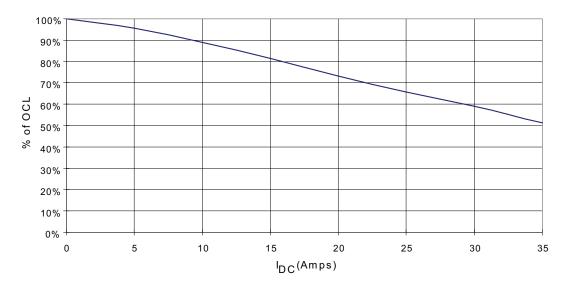
Core Loss





inductance Characteristics

% of OCL vs I_{DC}



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Solder Reflow Profile

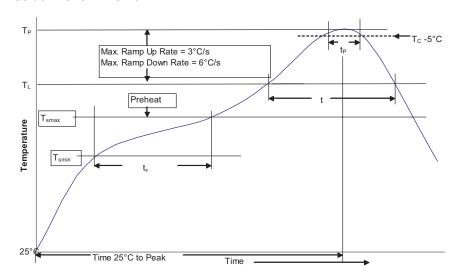


Table 1 - Standard SnPb Solder (T_C)

Package	Volume mm³	Volume mm³
Thickness	<350	≥350
<2.5mm	235°C	220°C
≥2.5mm	220°C	220°C

Table 2 - Lead (Pb) Free Solder (Tc)

Package	Volume mm³	Volume mm³	Volume mm³
Thickness	<350	350 - 2000	>2000
<1.6mm	260°C	260°C	260°C
1.6 - 2.5mm	260°C	250°C	245°C
>2.5mm	250°C	245°C	245°C

Reference JDEC J-STD-020D

Profile Feature		Standard SnPb Solder	Lead (Pb) Free Solder	
Preheat and Soak	• Temperature min. (T _{smin})	100°C	150°C	
	Temperature max. (T _{smax})	150°C	200°C	
	Time (T _{smin} to T _{smax}) (t _s)	60-120 Seconds	60-120 Seconds	
Average ramp up rate T _{smax} to T _p		3°C/ Second Max.	3°C/ Second Max.	
Liquidous temperature (TL) Time at liquidous (tL)		183°C 60-150 Seconds	217°C 60-150 Seconds	
Peak package body temperature (Tp)*		Table 1	Table 2	
Time $(t_p)^{**}$ within 5 °C of the specified classification temperature (T_c)		20 Seconds**	30 Seconds**	
Average ramp-down rate (T _p to T _{smax})		6°C/ Second Max.	6°C/ Second Max.	
Time 25°C to Peak Temperature		6 Minutes Max.	8 Minutes Max.	

 $^{^{\}star}$ Tolerance for peak profile temperature (Tp) is defined as a supplier minimum and a user maximum.

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^{**} Tolerance for time at peak profile temperature (tp) is defined as a supplier minimum and a user maximum.

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